MOTOROLA

Rail-To-Rail Operational Amplifiers with Enable Feature

MC33206
MC33207

**LOW VOLTAGE
RAIL–TO–RAIL
OPERATIONAL AMPLIFIERS**

**SEMICONDUCTOR
TECHNICAL DATA**

The MC33206/7 family of operational amplifiers provide rail–to–rail operation on both the input and output. The inputs can be driven as high as 200 mV beyond the supply rails without phase reversal on the outputs and the output can swing within 50 mV of each rail. This rail–to–rail operation enables the user to make full use of the supply voltage range available. It is designed to work at very low supply voltages ($\pm$0.9 V) yet can operate with a single supply of up to 12 V and ground. Output current boosting techniques provide a high output current capability while keeping the drain current of the amplifier to a minimum.

The MC33206/7 has an enable mode that can be controlled externally. The typical supply current in the standby mode is <1.0 μA (V_{Enable} = Gnd). The addition of an enable function makes this amplifier an ideal choice for power sensitive applications, battery powered equipment (instrumentation and monitoring), portable telecommunication, and sample–and–hold applications.
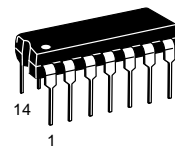
- Standby Mode ($I_D \leq 1.0$ μA, Typ)

- Low Voltage, Single Supply Operation
  (1.8 V and Ground to 12 V and Ground)

- Rail–to–Rail Input Common Mode Voltage Range

- Output Voltage Swings within 50 mV of both Rails

- No Phase Reversal on the Output for Over–Driven Input Signals

- High Output Current (I_{SC} = 80 mA, Typ)

- Low Supply Current (I_D = 0.9 mA, Typ)

- 600 Ω Output Drive Capability

- Typical Gain Bandwidth Product = 2.2 MHz

MC33206

P SUFFIX
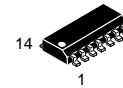PLASTIC PACKAGE
CASE 646

D SUFFIX
PLASTIC PACKAGE
CASE 751A
(SO–14)

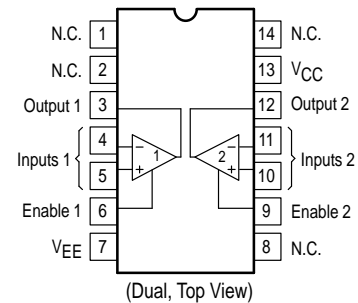|		
N.C. 1	14	N.C.
N.C. 2	13	V_{CC}
Output 1 3	12	Output 2
Inputs 1 { 4 5	11 10	} Inputs 2
Enable 1 6	9	Enable 2
V_{EE} 7	8	N.C.

(Dual, Top View)
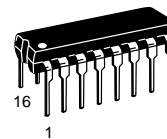
MC33207

P SUFFIX
PLASTIC PACKAGE
CASE 648

D SUFFIX
PLASTIC PACKAGE
CASE 751B
(SO–16)

Output 1 1	16	Enable 1, 4
Inputs 1 { 2 3	15 14	Output 4, } Inputs 4
V_{CC} 4	13	
Inputs 2 { 5 6	12 11	V_{EE}, } Inputs 3
Output 2 7	10	
Enable 2, 3 8	9	Output 3

(Quad, Top View)

ORDERING INFORMATION

Operational Amplifier Function	Device	Operating Temperature Range	Package
Dual	MC33206D	T_A= –40 ° to +105°C	SO–14
	MC33206P		Plastic DIP
Quad	MC33207D		SO–16
	MC33207P		Plastic DIP

© Motorola, Inc. 1999

Rev 1
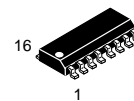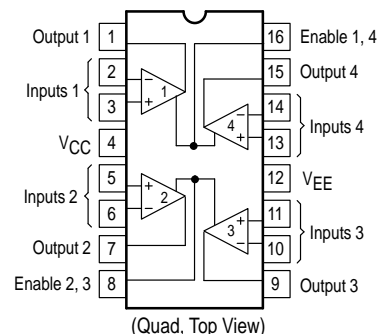
MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage (V_{CC} to V_{EE})	V_S	13	V
ESD Protection Voltage at any Pin Human Body Model	V_{ESD}	2,000	V
Voltage at any Device Pin	V_{DP}	$V_S \pm 0.5$	V
Input Differential Voltage Range	V_{IDR}	(Note 1)	V
Common Mode Input Voltage Range (Note 2)	V_{CM}	$V_{CC} + 0.5$ to $V_{EE} - 0.5$	V
Output Short Circuit Duration (Note 3)	t_s	(Note 3)	sec
Maximum Junction Temperature	T_J	+150	°C
Storage Temperature Range	T_{stg}	−65 to +150	°C
Maximum Power Dissipation	P_D	(Note 3)	mW

NOTES: 1. The differential input voltage of each amplifier is limited by two internal parallel back–to–back diodes. For additional differential input voltage range, use current limiting resistors in series with the input pins.
2. The common–mode input voltage range of each amplifier is limited by diodes connected from the inputs to both power supply rails. Therefore, the voltage on either input must not exceed either supply rail by more than 500 mV.
3. Power dissipation must be considered to ensure maximum junction temperature (T_J) is not exceeded.
4. ESD data available upon request.

DC ELECTRICAL CHARACTERISTICS (V_{CC} = 5.0 V, V_{EE} = 0 V, V_{Enable} = 5.0 V, T_A = 25°C, unless otherwise noted.)

Characteristic	Figure	Symbol	Min	Typ	Max	Unit

Input Offset Voltage (V_{CM} 0 to 0.5 V, V_{CM} 1.0 to 5.0 V)
MC33206: T_A = 25°C
     T_A = −40° to +105°C
MC33207: T_A = 25°C
     T_A = −40° to +105°C
	–	V_{IO}	–
			–
			–
			–
				0.5
				1.0
				0.5
				1.0
					8.0
					11
					10
					13
						mV

Input Offset Voltage Temperature Coefficient (R_S = 50 Ω) T_A = −40° to +105°C	–	$\Delta V_{IO}/\Delta T$	–	2.0	–	µV/°C
Input Bias Current (V_{CM} = 0 to 0.5 V, V_{CM} = 1.0 to 5.0 V) T_A = 25°C T_A = −40° to +105°C	–	$\|I_{IB}\|$	– –	80 100	200 250	nA
Input Offset Current (V_{CM} = 0 to 0.5 V, V_{CM} = 1.0 to 5.0 V) T_A = 25°C T_A = −40° to +105°C	–	$\|I_{IO}\|$	– –	5.0 10	50 100	nA
Common Mode Input Voltage Range	–	V_{ICR}	– V_{EE}	$V_{CC} + 0.2$ $V_{EE} - 0.2$	V_{CC} –	V
Large Signal Voltage Gain (V_{CC} = 5.0 V, V_{EE} = −5.0 V) R_L = 10 kΩ R_L = 600 Ω	–	A_{VOL}	50 25	300 250	– –	kV/V
Output Voltage Swing (V_{ID} = ±0.2 V) R_L = 10 kΩ R_L = 10 kΩ R_L = 600 Ω R_L = 600 Ω	–	V_{OH} V_{OL} V_{OH} V_{OL}	4.85 – 4.75 –	4.95 0.05 4.85 0.15	– 0.15 – 0.25	V
Common Mode Rejection (V_{in} = 0 to 5.0 V)	–	CMR	60	90	–	dB
Power Supply Rejection Ratio V_{CC}/V_{EE} = 5.0 V/Gnd to 3.0 V/Gnd	–	PSRR PSR	– 66	25 92	500 –	µV/V dB
Output Short Circuit Current (Source and Sink)	–	I_{SC}	50	80	–	mA

DC ELECTRICAL CHARACTERISTICS (continued) (V_{CC} = 5.0 V, V_{EE} = 0 V, V_{Enable} = 5.0 V, T_A = 25°C, unless otherwise noted.)

| Characteristic	Figure	Symbol	Min	Typ	Max	Unit
Power Supply Current (V_O = 2.5 V, T_A = −40° to +105°C, per Amplifier)	–	I_D				
MC33206: V_{Enable} = 5.0 Vdc			–	0.8	1.125	mA
V_{Enable} = Gnd (Standby)			–	0.5	6.0	μA
MC33207: V_{Enable} = 5.0 Vdc			–	1.5	2.25	mA
V_{Enable} = Gnd (Standby)			–	0.5	6.0	μA
Enable Input Voltage (per Amplifier)	–	V_{Enable}				V
Enabled – Amplifier "On"			–	V_{EE} + 1.8	–	
Disabled – Amplifier "Off" (Standby)			–	V_{EE} + 0.3	–	
Enable Input Current (Note 5) (per Amplifier)	–	I_{Enable}				μA
V_{Enable} = 12 V			–	2.5	–	
V_{Enable} = 5.0 V			–	2.2	–	
V_{Enable} = 1.8 V			–	0.8	–	
V_{Enable} = Gnd			–	0	–	

NOTE: 5. External control circuitry must provide for an initial turn–off transient of <10 μA.

AC ELECTRICAL CHARACTERISTICS (V_{CC} = 5.0 V, V_{EE} = 0 V, V_{Enable} = 5.0 V, T_A = 25°C, unless otherwise noted.)

Characteristic	Figure	Symbol	Min	Typ	Max	Unit
Slew Rate (V_S = ±2.5 V, V_O = −2.0 to +2.0 V, R_L = 2.0 kΩ, A_V = 1.0)	–	SR	0.5	1.0	–	V/μs
Gain Bandwidth Product (f = 100 kHz)	–	GBW	–	2.2	–	MHz
Phase Margin (R_L = 600 Ω, C_L = 0 pF)	–	$\emptyset_M$	–	65	–	Deg
Gain Margin (R_L = 600 Ω, C_L = 0 pF)	–	A_M	–	12	–	dB
Channel Separation (f = 1.0 Hz to 20 kHz, A_V = 100)	–	CS	–	90	–	dB
Power Bandwidth (V_O = 4.0 Vpp, R_L = 600 Ω, THD ≤ 1%)	–	BW_P	–	28	–	kHz
Total Harmonic Distortion (R_L = 600 Ω, V_O = 1.0 Vpp, A_V = 1.0)	–	THD				%
f = 1.0 kHz			–	0.002	–	
f = 10 kHz			–	0.008	–	
Open Loop Output Impedance (V_O = 0 V, f = 2.0 MHz, A_V = 10)	–	$|Z_O|$	–	100	–	Ω
Differential Input Resistance (V_{CM} = 0 V)	–	R_{in}	–	200	–	kΩ
Differential Input Capacitance (V_{CM} = 0 V)	–	C_{in}	–	8.0	–	pF
Equivalent Input Noise Voltage (R_S = 100 Ω)	–	e_n				nV/$\sqrt{Hz}$
f = 10 Hz			–	25	–	
f = 1.0 kHz			–	20	–	
Equivalent Input Noise Current	–	i_n				pA/$\sqrt{Hz}$
f = 10 Hz			–	0.8	–	
f = 1.0 kHz			–	0.2	–	
Time Delay for Device to Turn On	–	t_{on}	–	10	–	μs
Time Delay for Device to Turn Off	–	t_{off}	–	2.0	–	μs

MOTOROLA ANALOG IC DEVICE DATA

3
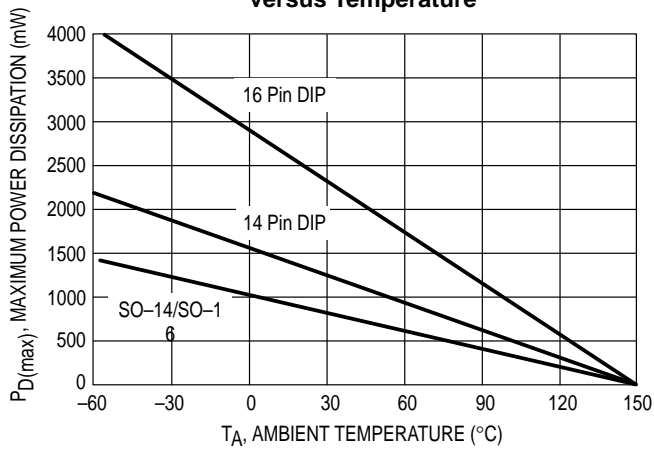
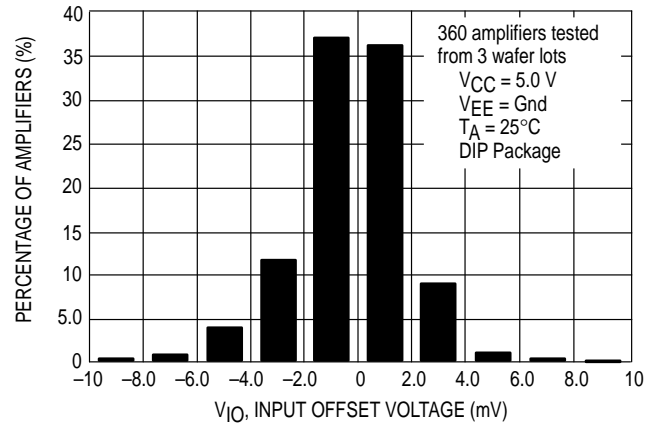**Figure 1. Circuit Schematic**
(Each Amplifier)
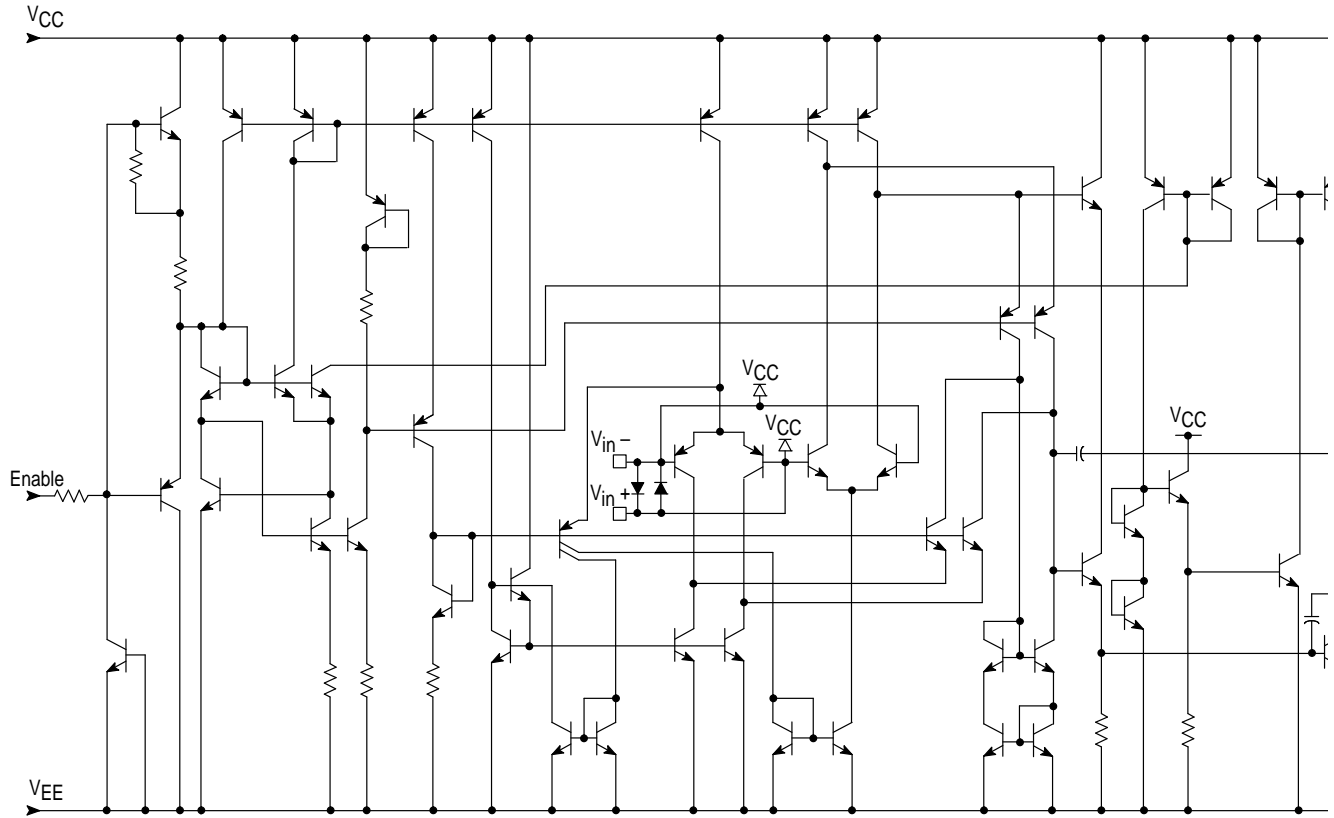
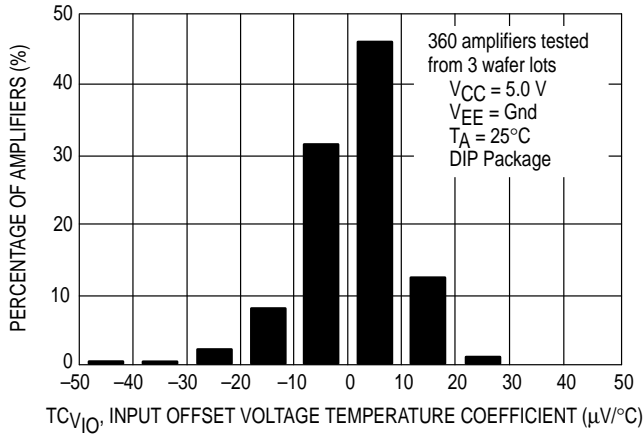This device contains 96 active transistors (each amplifier).

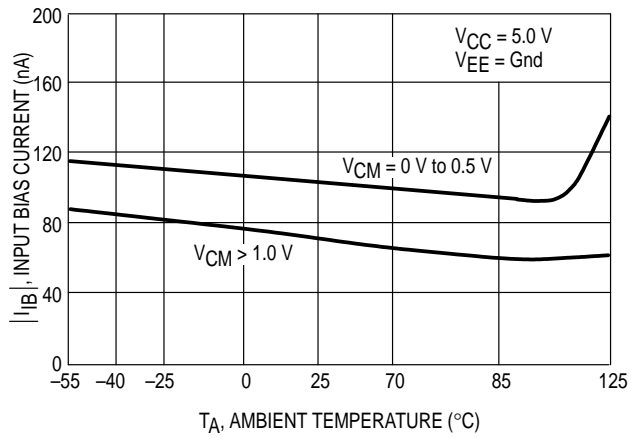**Figure 2. Maximum Power Dissipation versus Temperature**

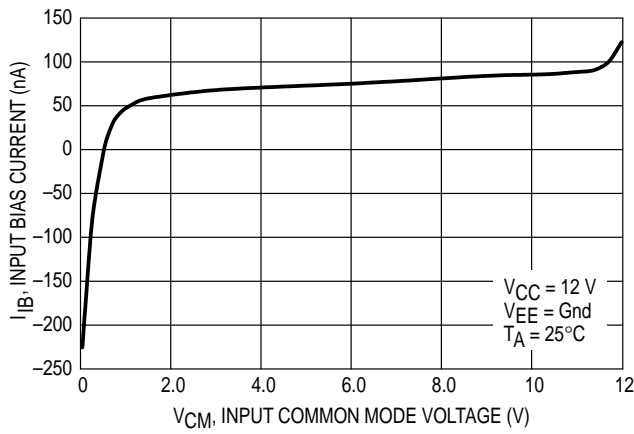**Figure 3. Input Offset Voltage Distribution**

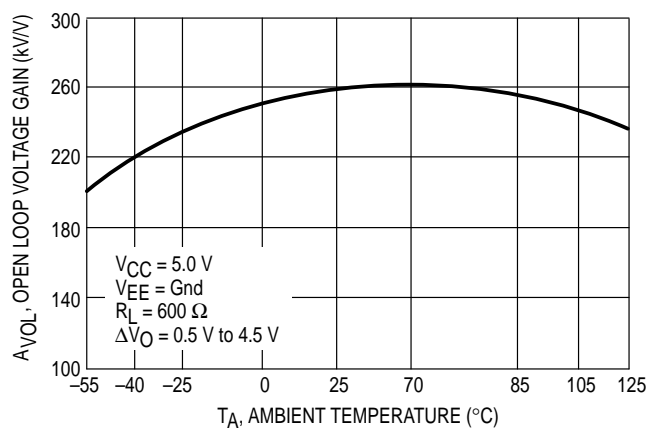## Figure 4. Input Offset Voltage Temperature Coefficient Distribution

360 amplifiers tested from 3 wafer lots
V_{CC} = 5.0 V
V_{EE} = Gnd
T_A = 25°C
DIP Package

PERCENTAGE OF AMPLIFIERS (%)

$TC_{V_{IO}}$, INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT (µV/°C)

Figure 5. Input Bias Current versus Temperature

V_{CC} = 5.0 V
V_{EE} = Gnd

V_{CM} = 0 V to 0.5 V

V_{CM} > 1.0 V

$|I_{IB}|$, INPUT BIAS CURRENT (nA)

T_A, AMBIENT TEMPERATURE (°C)

Figure 6. Input Bias Current versus Common Mode Voltage

V_{CC} = 12 V
V_{EE} = Gnd
T_A = 25°C

I_{IB}, INPUT BIAS CURRENT (nA)

V_{CM}, INPUT COMMON MODE VOLTAGE (V)

Figure 7. Open Loop Voltage Gain versus Temperature

V_{CC} = 5.0 V
V_{EE} = Gnd
R_L = 600 Ω
ΔV_O = 0.5 V to 4.5 V

A_{VOL}, OPEN LOOP VOLTAGE GAIN (kV/V)

T_A, AMBIENT TEMPERATURE (°C)

Figure 8. Output Voltage Swing versus Supply Voltage

R_L = 600 Ω
T_A = 25°C

V_O, OUTPUT VOLTAGE (Vpp)

V_{CC}, $|V_{EE}|$ SUPPLY VOLTAGE (V)
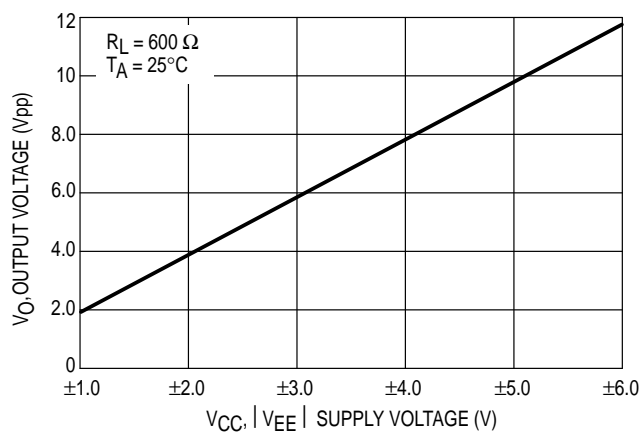
Figure 9. Output Saturation Voltage versus Load Current

T_A = −55°C
T_A = 125°C
T_A = 25°C

V_{CC} = 5.0 V
V_{EE} = −5.0 V
T_A = 25°C
T_A = 125°C
T_A = −55°C

V_{CC}
V_{CC} −
V_{CC} −
V_{EE} +
V_{EE} +
V_{EE}

V_{SAT}, OUTPUT SATURATION VOLTAGE (V)

I_L, LOAD CURRENT (mA)

MOTOROLA ANALOG IC DEVICE DATA

5
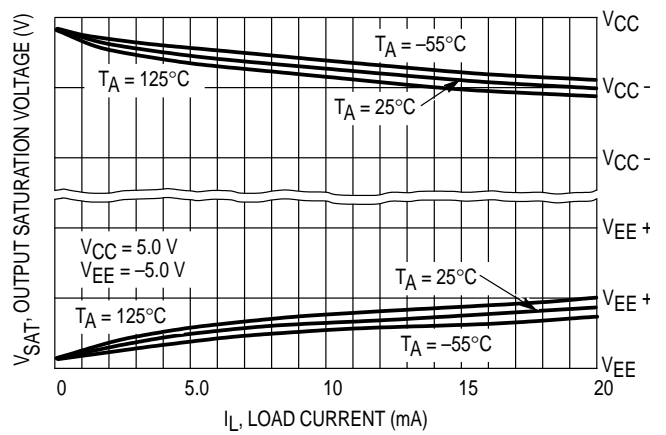
Figure 10. Output Voltage versus Frequency

V_CC = 6.0 V
V_EE = −6.0 V
R_L = 600 Ω
A_V = 1.0
T_A = 25°C

V_O, OUTPUT VOLTAGE (Vpp)
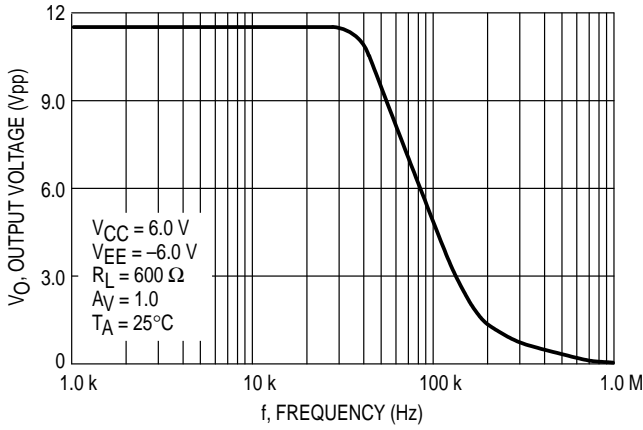
f, FREQUENCY (Hz)

Figure 11. Common Mode Rejection versus Frequency

V_CC = 6.0 V
V_EE = −6.0 V
T_A = −55° to +125°C

CMR, COMMON MODE REJECTION (dB)
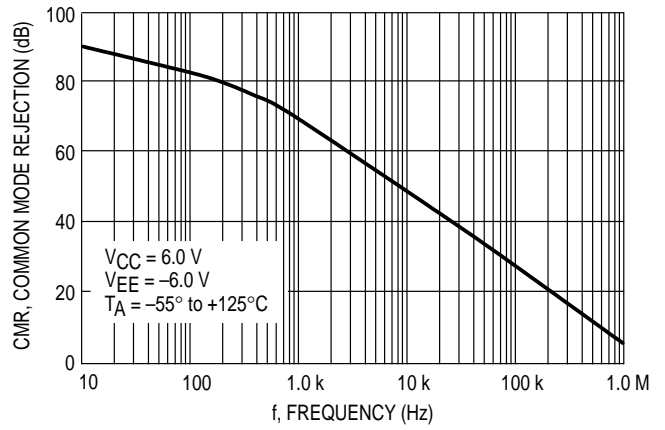
f, FREQUENCY (Hz)

Figure 12. Power Supply Rejection versus Frequency

PSR+
PSR−

V_CC = 6.0 V
V_EE = −6.0 V
T_A = −55° to +125°C

PSR, POWER SUPPLY REJECTION (dB)

f, FREQUENCY (Hz)
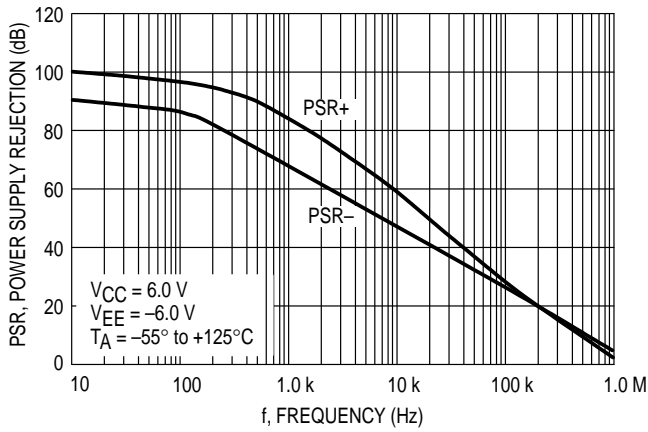
Figure 13. Output Short Circuit Current versus Output Voltage

Source
Sink

V_CC = 6.0 V
V_EE = −6.0 V
T_A = 25°C

$|I_{SC}|$, OUTPUT SHORT CIRCUIT CURRENT (mA)

$|V_{out}|$, OUTPUT VOLTAGE (V)
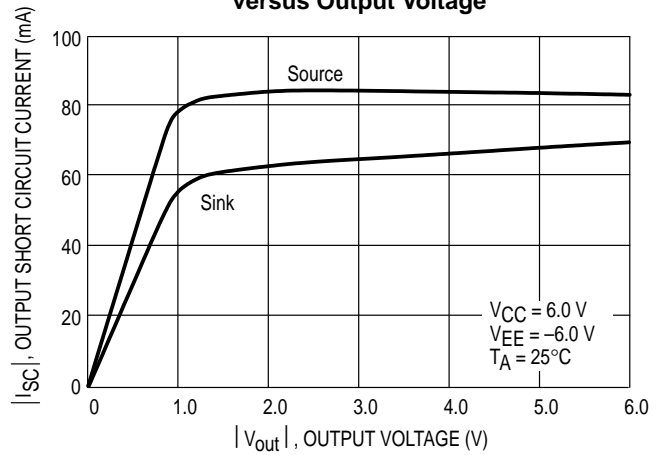
Figure 14. Output Short Circuit Current versus Temperature

V_CC = 5.0 V
V_EE = Gnd

Source
Sink

$|I_{SC}|$, OUTPUT SHORT CIRCUIT CURRENT (mA)

T_A, AMBIENT TEMPERATURE (°C)
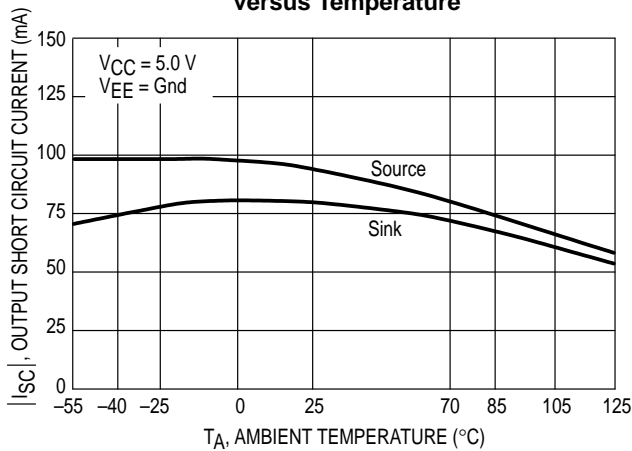
Figure 15. Supply Current per Amplifier versus Supply Voltage with No Load

T_A = 125°C
T_A = 25°C
T_A = −55°C

I_{CC}, SUPPLY CURRENT PER AMPLIFIER (mA)
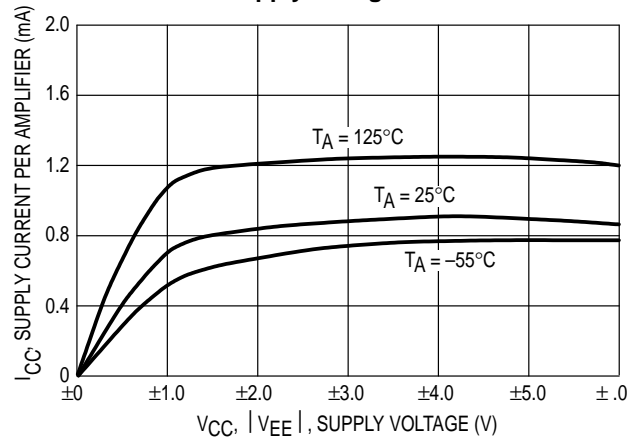
V_CC, $|V_{EE}|$, SUPPLY VOLTAGE (V)

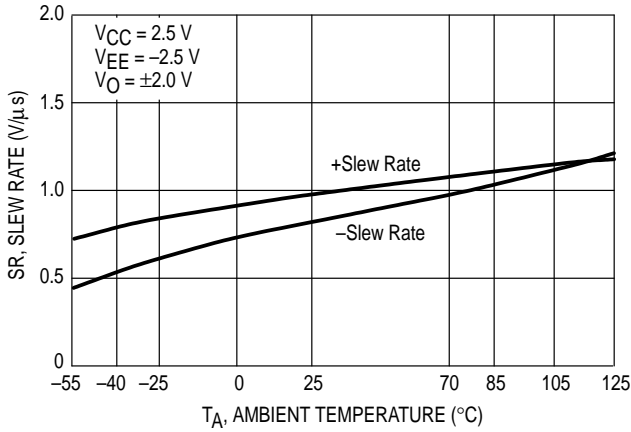**Figure 16. Slew Rate
versus Temperature**

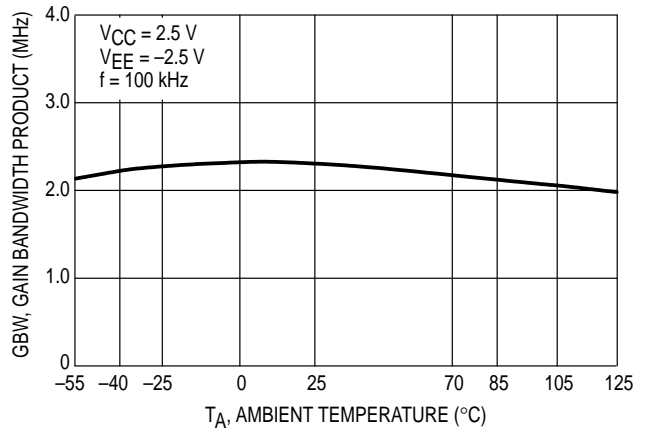**Figure 17. Gain Bandwidth Product
versus Temperature**

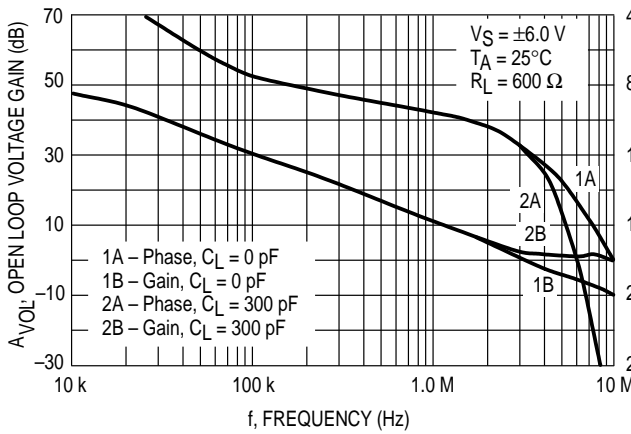**Figure 18. Voltage Gain and Phase
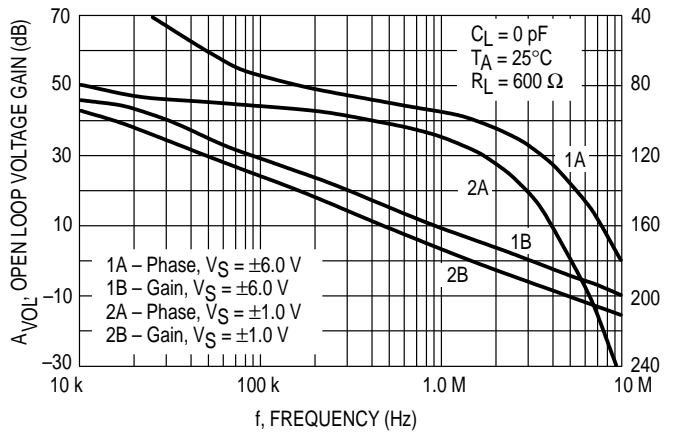versus Frequency**

**Figure 19. Voltage Gain and Phase
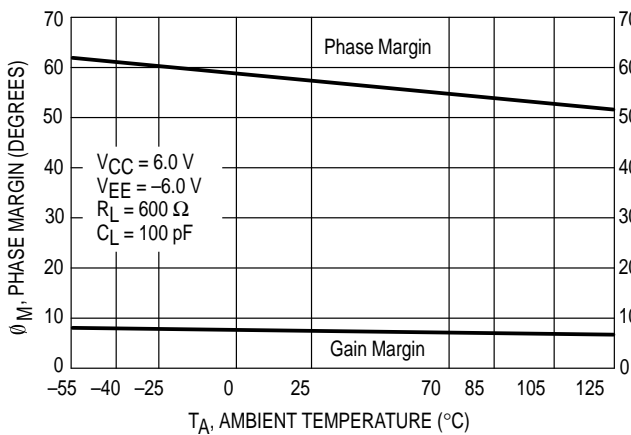versus Frequency**

**Figure 20. Gain and Phase Margin
versus Temperature**

**Figure 21. Gain and Phase Margin
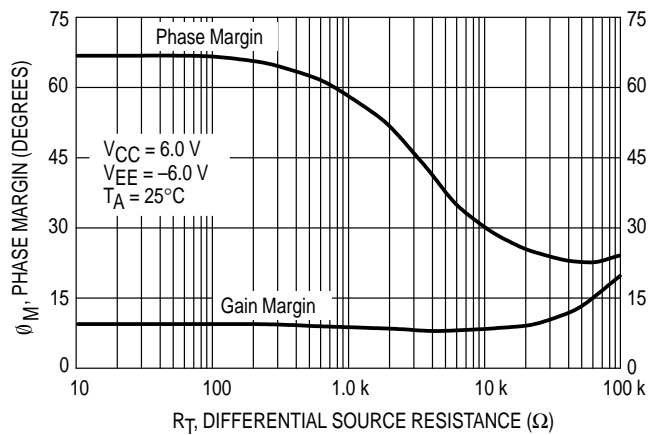versus Differential Source Resistance**

MOTOROLA ANALOG IC DEVICE DATA

7

**Figure 22. Gain and Phase Margin
versus Capacitive Load**

V_{CC} = 6.0 V
V_{EE} = −6.0 V
R_L = 600 Ω
A_V = 100
T_A = 25°C

Phase Margin
Gain Margin

$\emptyset_M$, PHASE MARGIN (DEGREES)
A_M, GAIN MARGIN (dB)
C_L, CAPACITIVE LOAD (pF)
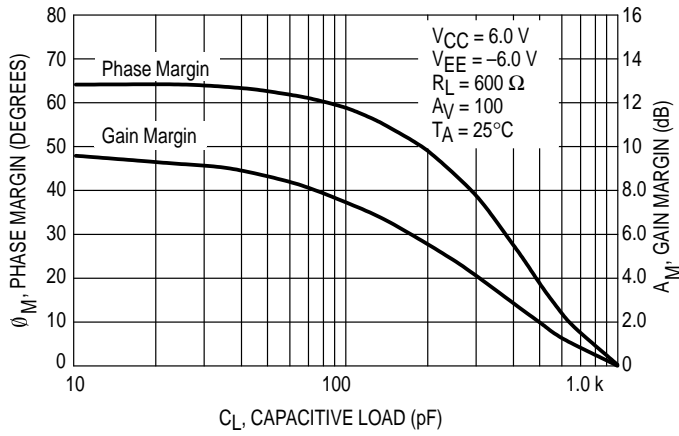
**Figure 23. Output Voltage
versus Load Resistance**

V_{CC} = 5.0 Vdc
V_{CC} = 2.0 Vdc

V_{EE} = Gnd
C_L = 0 pF
A_V = 1.0
T_A = 25°C

V_O, OUTPUT VOLTAGE (Vpp)
R_L, LOAD RESISTANCE
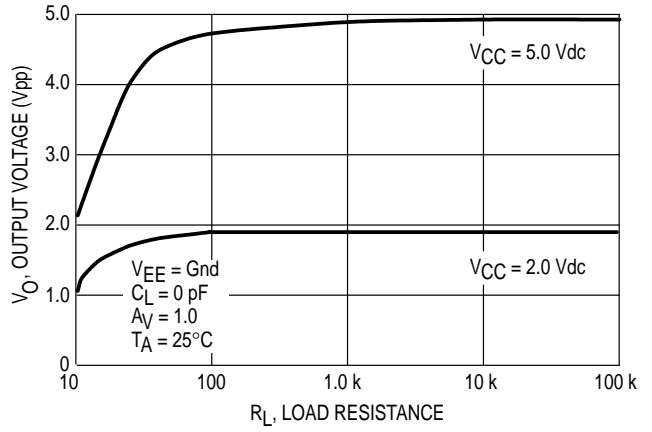
**Figure 24. Channel Separation
versus Frequency**

A_V = 100
A_V = 10

V_{CC} = 6.0 V
V_{EE} = −6.0 V
V_O = 8.0 Vpp
T_A = 25°C

CS, CHANNEL SEPARATION (dB)
f, FREQUENCY (Hz)
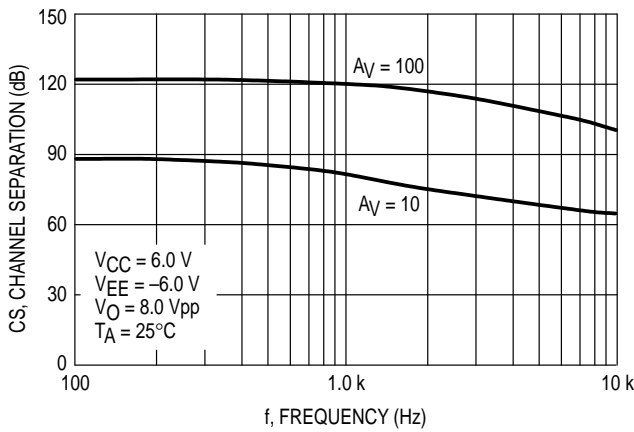
**Figure 25. Total Harmonic Distortion
versus Frequency**

V_{CC} = 5.0 V V_{EE} = −5.0 V
T_A = 25°C R_L = 600 Ω
V_O = 2.0 Vpp

A_V = 1000
A_V = 100
A_V = 10
A_V = 1.0

THD, TOTAL HARMONIC DISTORTION (%)
f, FREQUENCY (Hz)
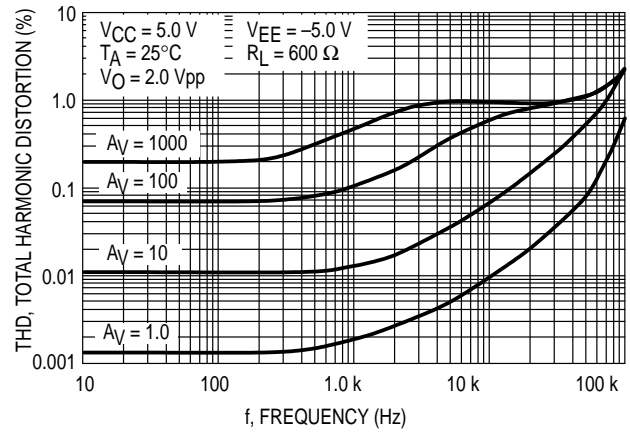
**Figure 26. Equivalent Input Noise Voltage
and Current versus Frequency**

V_{CC} = 6.0 V
V_{EE} = −6.0 V
T_A = 25°C

Noise Voltage
Noise Current

e_n, EQUIVALENT INPUT NOISE VOLTAGE (nV/$\sqrt{Hz}$)
i_n, INPUT REFERRED NOISE CURRENT (pA/$\sqrt{Hz}$)
f, FREQUENCY (Hz)
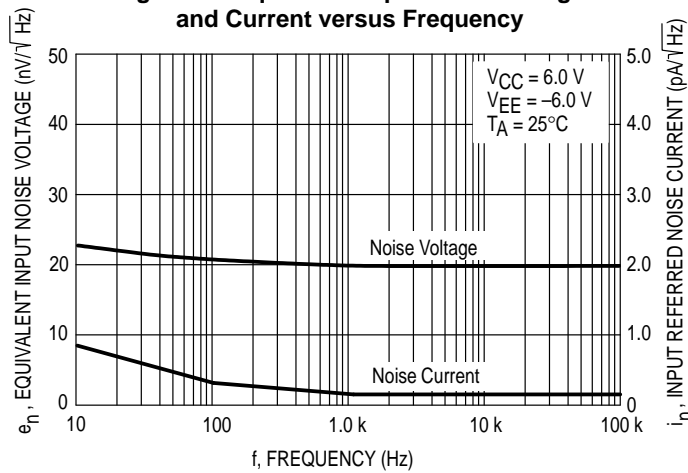
MC33206 MC33207

GENERAL INFORMATION

The MC33206/7 family of operational amplifiers are unique in their ability to swing rail–to–rail on both the input and the output with a completely bipolar design. This offers low noise, high output current capability and a wide common mode input voltage range even with low supply voltages. Operation is guaranteed over an extended temperature range and at supply voltages of 2.0 V, 3.3 V and 5.0 V and ground.

Since the common mode input voltage range extends from V_{CC} to V_{EE}, it can be operated with either single or split voltage supplies. The MC33206/7 are guaranteed not to latch or phase reverse over the entire common mode range, however, the inputs should not be allowed to exceed maximum ratings.

CIRCUIT INFORMATION

Rail–to–rail performance is achieved at the input of the amplifiers by using parallel NPN–PNP differential input stages. When the inputs are within 800 mV of the negative rail, the PNP stage is on. When the inputs are more than 800 mV greater than V_{EE}, the NPN stage is on. This switching of input pairs will cause a reversal of input bias currents (see Figure 6). Also, slight differences in offset voltage may be noted between the NPN and PNP pairs. Cross–coupling techniques have been used to keep this change to a minimum.

In addition to its rail–to–rail performance, the output stage is current boosted to provide 80 mA of output current, enabling the op amp to drive 600 Ω loads. Because of this high output current capability, care should be taken not to exceed the 150°C maximum junction temperature.

Enable Function

The MC33206/07 enable pins allow the user to externally control the device. (Refer to the Pin Diagram on the first page of this data sheet for enable pin connections.) If the enable pins are pulled low (Gnd) each amplifier (MC33206) and amplifier pair (MC33207) will be disabled. When the enable pins are at a logic high ($V_{Enable} \geq V_{EE} = 1.8$ V) the amplifiers will turn "on". Refer to the data sheet characteristics for the required levels needed to change logical state.

The time to change states (from device "on" to "off" and "off" to "on") is defined as the time delay. The Circuit in Figure 27 is used to measure t_{on} and t_{off}. Typical t_{on} and t_{off} measurements are shown in Figures 28 and 29. When the device is turned off ($V_{Enable} = $ Gnd) an internal regulator is shut off disabling the amplifier.
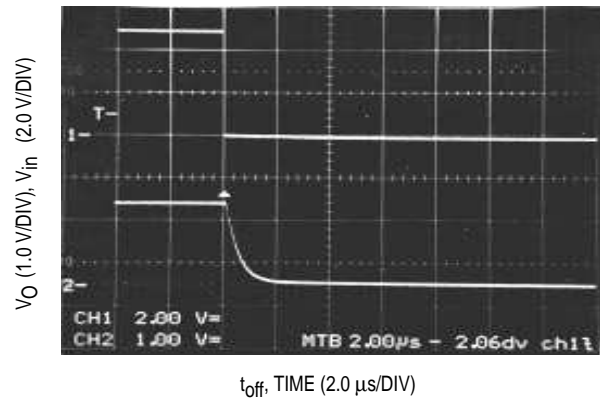
Figure 27. Test Circuit for t_{on} and t_{off}
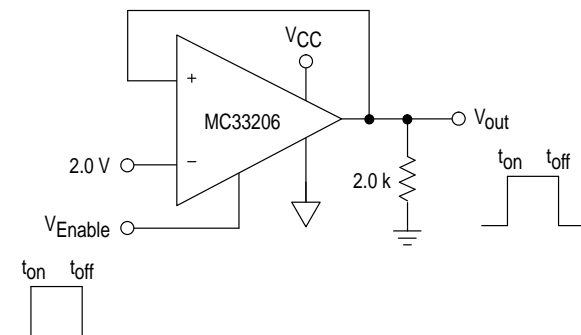
Figure 28. t_{on} Response

t_{on}, TIME (2.0 μs/DIV)
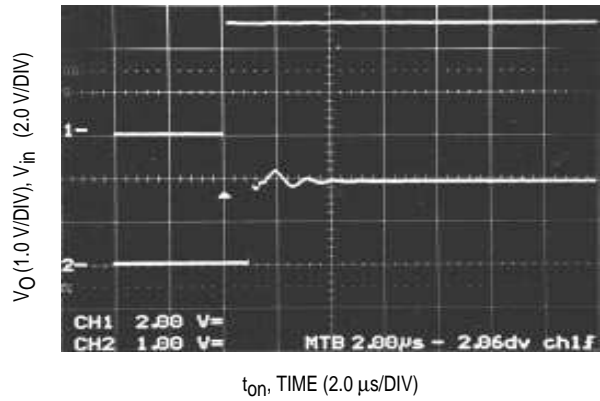
Figure 29. t_{off} Response

t_{off}, TIME (2.0 μs/DIV)

Low Voltage Operation

The MC33206/07 will operate at supply voltages down to 1.8 V and ground. Since this device is a rail–to–rail on both the input and output, one can be assured of continued operation in battery applications when battery voltages drop to low voltage levels. This is called End of Discharge (see Figure 30). Now, the user can select a minimum quantity of batteries best suited for the particular design depending on the type of battery chosen. This will minimize part count in many designs.

Figure 30. Typical Battery Characteristics

Type	Operating Voltage	End of Discharge
Alkaline	1.5 V	0.9 V
NiCd	1.2 V	1.0 V
NiMh	1.2 V	1.0 V
Silver Oxide	1.6 V	1.3 V
Lithium Ion	3.6 V	2.5 V

Compensating for Output Capacitance

The combination of device output impedance and increasing capacitive loading will cause phase delay (reducing the phase margin) in any amplifier (Figure 22). If the loading is excessive, the resulting response can be circuit oscillation. In other words, an amplifier can become unstable when the phase becomes greater than 180 degrees before the open loop gain drops to unity gain. Figures 18 and 19 show this situation as frequency increases for a given load. The MC33206/7 can typically drive up to 300 pF loads at unity gain without oscillating.

Figure 31. Capacitive Loads Compensation
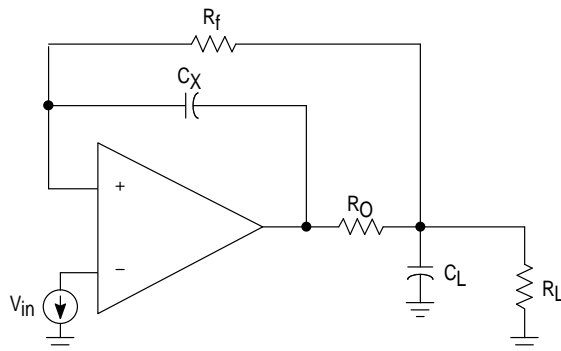
There are several ways to compensate for this phenomena. Adding series resistance to the output is one way, but not an ideal solution. A dc voltage error will occur at the output. A better design solution to compensate for higher capacitive loads would be to use the circuit in Figure 31. This design helps to counteract the loss of phase margin by taking the high frequency output signal and feeding it back into the amplifier inverting input. This technique helps to overcome oscillation due to a highly capacitive load. Keep in mind that compensation will have the affect of lowering the Gain Bandwidth Product (GPW). The values of C_X and R0, are determined experimentally. Typical C_X and C_L will be the same value.

SPICE Model

If a SPICE Macromodel is desired for the MC33206/07, the user can define the characteristics from the following information. Obtain the SPICE Macromodel for the MC33204 Rail–to–Rail Operational Amplifier (device is the same as the MC33207). For the Enable feature of the MC33207, simulate it as a bipolar switch. The Macromodel does not include an input capacitance between the inverting and noninverting inputs. This capacitor is called C_{in}. Add 3.0 to 5.0 pF if stability analysis is required.
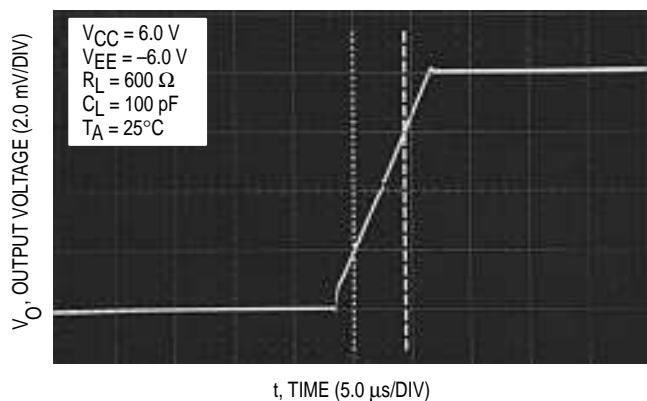
Figure 32. Noninverting Amplifier Slew Rate

V_{CC} = 6.0 V
V_{EE} = −6.0 V
R_L = 600 Ω
C_L = 100 pF
T_A = 25°C

V_O, OUTPUT VOLTAGE (2.0 mV/DIV)

t, TIME (5.0 μs/DIV)

Figure 33. Small Signal Transient Response

V_{CC} = 6.0 V
V_{EE} = −6.0 V
R_L = 600 Ω
C_L = 100 pF
T_A = 25°C

V_O, OUTPUT VOLTAGE (50 mV/DIV)

t, TIME (10 μs/DIV)
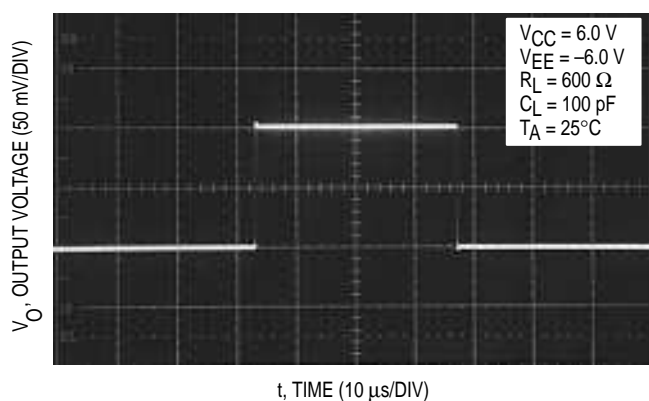
Figure 34. Large Signal Transient Response

V_{CC} = 6.0 V
V_{EE} = −6.0 V
R_L = 600 Ω
C_L = 100 pF
A_V = 1.0
T_A = 25°C

V_O, OUTPUT VOLTAGE (2.0 V/DIV)

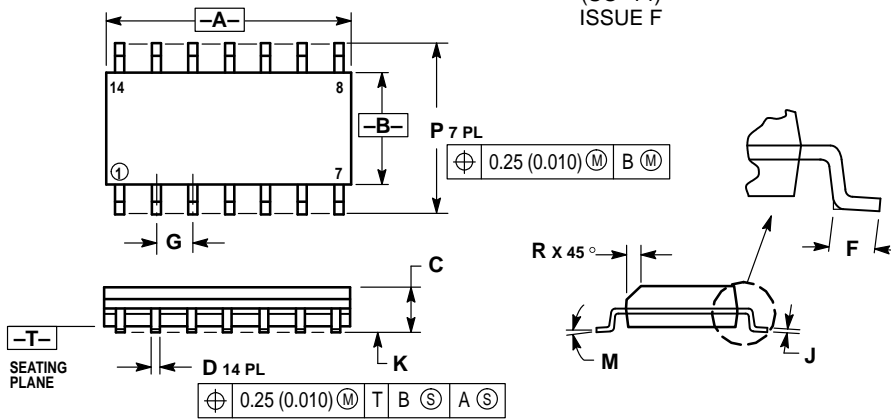t, TIME (10 μs/DIV)
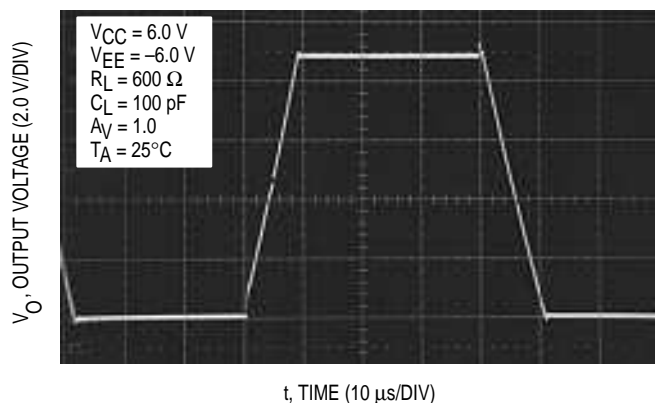
OUTLINE DIMENSIONS

P SUFFIX
PLASTIC PACKAGE
CASE 646–06
ISSUE L
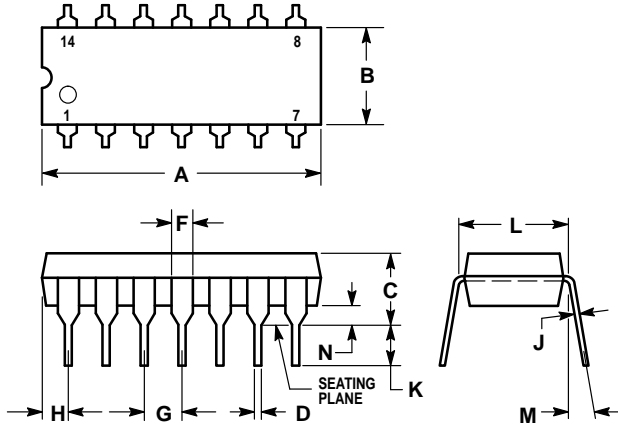
NOTES:
1. LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
4. ROUNDED CORNERS OPTIONAL.

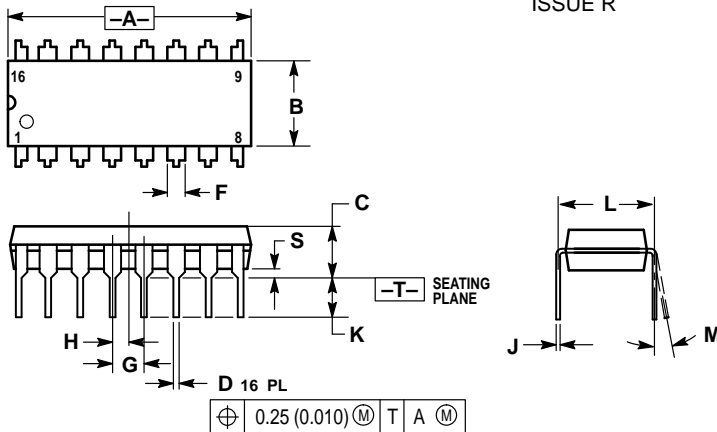| DIM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	0.715	0.770	18.16	19.56
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.300 BSC		7.62 BSC	
M	0°	10°	0°	10°
N	0.015	0.039	0.39	1.01

D SUFFIX
PLASTIC PACKAGE
CASE 751A–03
(SO–14)
ISSUE F

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

P 7 PL

$\oplus$ | 0.25 (0.010) (M) | B (M)

$\oplus$ | 0.25 (0.010) (M) | T | B (S) | A (S)

D 14 PL

R X 45°

DIM	MILLIMETERS MIN	MILLIMETERS MAX	INCHES MIN	INCHES MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

P SUFFIX
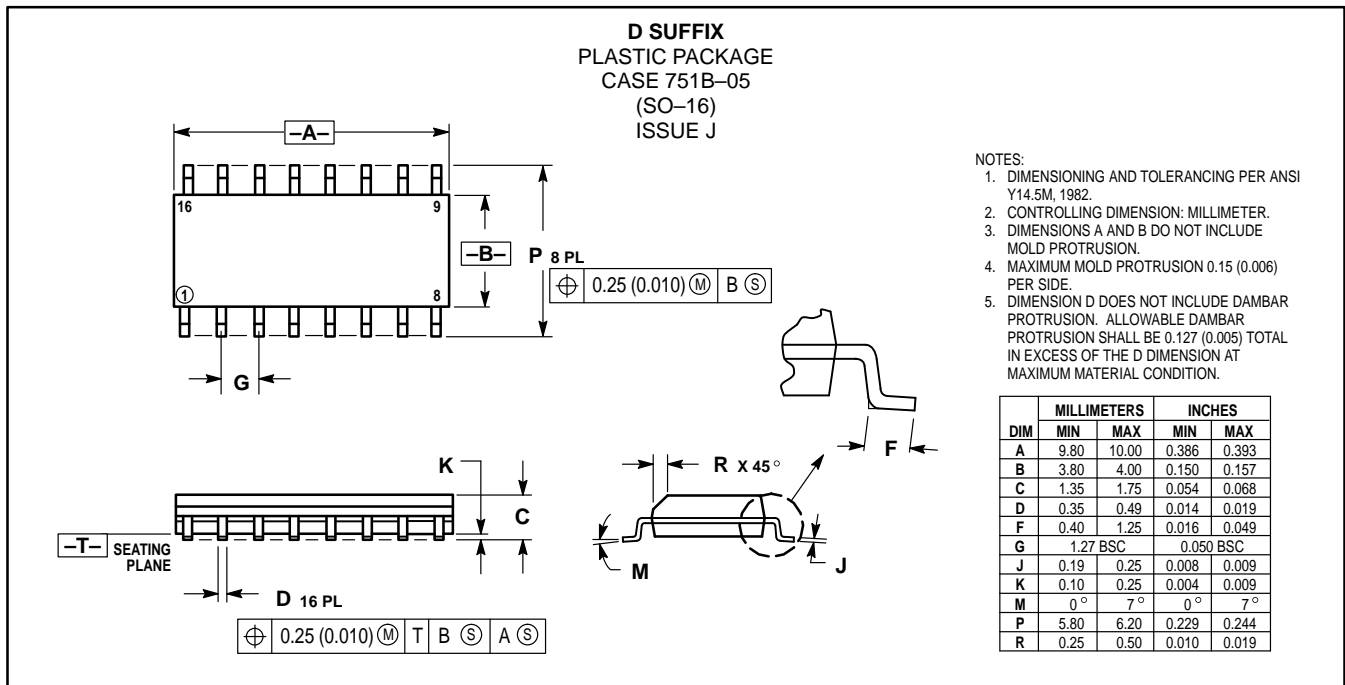PLASTIC PACKAGE
CASE 648–08
ISSUE R

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

$\oplus$ | 0.25 (0.010) (M) | T | A (M)

D 16 PL

DIM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

OUTLINE DIMENSIONS

D SUFFIX
PLASTIC PACKAGE
CASE 751B–05
(SO–16)
ISSUE J

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
---	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0 °	7 °	0 °	7 °
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

Mfax is a trademark of Motorola, Inc.

How to reach us:
USA/EUROPE/Locations Not Listed: Motorola Literature Distribution;
P.O. Box 5405, Denver, Colorado 80217. 1–303–675–2140 or 1–800–441–2447

JAPAN: Motorola Japan Ltd.; SPD, Strategic Planning Office, 141,
4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan. 81–3–5487–8488

Customer Focus Center: 1–800–521–6274

Mfax™: RMFAX0@email.sps.mot.com – TOUCHTONE 1–602–244–6609
Motorola Fax Back System
  – US & Canada ONLY 1–800–774–1848
  – http://sps.motorola.com/mfax/
HOME PAGE: http://motorola.com/sps/

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; Silicon Harbour Centre,
2, Dai King Street, Tai Po Industrial Estate, Tai Po, N.T., Hong Kong.
852–26629298

MOTOROLA

◊

MC33206/D